



COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Product Summary

Device	BVDSS	R _{DS(ON)} Max	I _D Max T _A = +25°C
04	20	0.4Ω @ V _{GS} = 10V	0.8A
Q1	30	0.7Ω @ V _{GS} = 4.5V	0.62A
00	00	0.9Ω @ V _{GS} = -10V	-0.55A
Q2	-30	1.7Ω @ V _{GS} = -4.5V	-0.4A

Description and Applications

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Motor controls
- Power management functions
- DC-DC converters

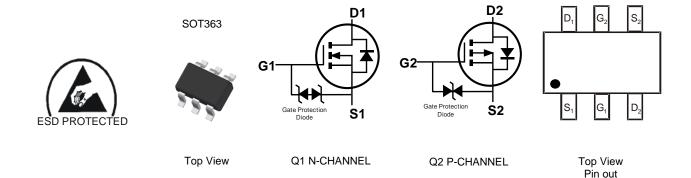
Features and Benefits

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Package: SOT363
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.027 grams (Approximate)



Ordering Information (Note 4)

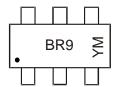
Part Number	Package	Packing			
Part Number	Раскауе	Qty.	Carrier		
DMC3401LDW-7	SOT363	3000	Tape & Reel		
DMC3401LDW-13	SOT363	10000	Tape & Reel		

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information



BR9 = Product Type Marking Code YM = Date Code Marking Y or \overline{Y} or \underline{Y} = Year (ex: J = 2022) M = Month (ex: 9 = September)

Date Code Key

Year	2018		2022	2023	2024	2025	2026	2027	2028	2029	2030	2031
Code	F		J	K	L	М	N	0	Р	R	S	T
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec

Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value_Q1	Value_Q2	Unit
Drain-Source Voltage			VDSS	30	-30	V
Gate-Source Voltage			Vgss	±20	±20	V
Continuous Drain Current (Note 6) Q1: VGS = 10V Q2: VGS = -10V	Steady State	T _A = +25°C T _A = +70°C	lD	0.8 0.6	-0.55 -0.44	А
Maximum Continuous Body Diode Forward Curre	Is	0.4	-0.38	Α		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1	%)		I_{DM}	4	-2.4	А

Thermal Characteristics ($@T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		PD	0.29	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R _{0JA}	433	°C/W
Total Power Dissipation (Note 6)		PD	0.4	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	Reja	301	°C/W
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

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^{6.} Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.



Electrical Characteristics – N Channel – Q1 (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BVDSS	30		_	٧	$V_{GS} = 0V, I_{D} = 250\mu A$
Zero Gate Voltage Drain Current	IDSS		_	1.0	μΑ	$V_{DS} = 30V$, $V_{GS} = 0V$
Gate-Source Leakage	Igss		_	±10	μΑ	$V_{GS} = \pm 20V$, $V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	Vgs(th)	0.8	1.2	1.6	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
Static Drain-Source On-Resistance	Dagger		0.2	0.4	Ω	$V_{GS} = 10V, I_{D} = 0.59A$
Static Dialii-Source Off-Resistance	Rds(on)		0.3	0.7	12	$V_{GS} = 4.5V, I_{D} = 0.2A$
Diode Forward Voltage	VsD	_	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 0.1A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss	_	50	_	pF	V 45V V 9V
Output Capacitance	Coss	_	12	_	pF	V _{DS} = 15V, V _{GS} = 0V, f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	10	_	pF	1 = 1.0WHZ
Gate Resistance	Rg	_	58	_	Ω	$V_{DS} = V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge (Vgs = 4.5V)	Qg	_	0.5	_	nC	
Total Gate Charge (V _{GS} = 10V)	Q_g	_	1.2	_	nC	\/ 40\/ I- 250m \
Gate-Source Charge	Qgs	_	0.2	_	nC	$V_{DS} = 10V, I_{D} = 250mA$
Gate-Drain Charge	Qgd	_	0.1	_	nC	
Turn-On Delay Time	td(ON)	_	3.5	_	ns	
Turn-On Rise Time	t _R	_	3.3	_	ns	Vgs = 10V, Vps = 30V,
Turn-Off Delay Time	t _{D(OFF)}	_	16.8	_	ns	$I_D = 100 \text{mA}, R_G = 25 \Omega$
Turn-Off Fall Time	tF	_	13.8	_	ns	

Electrical Characteristics – P Channel – Q2 (@T_A = +25°C, unless otherwise specified.)

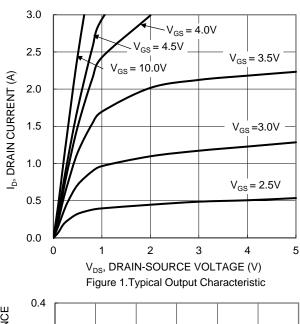
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BVDSS	-30	_	_	V	$V_{GS} = 0V, I_{D} = -250\mu A$
Zero Gate Voltage Drain Current	IDSS	_	_	-1	μΑ	V _{DS} = -24V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 16V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(TH)}	-1	-2.2	-2.6	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
Static Drain-Source On-Resistance	Dagger	_	0.5	0.9	Ω	$V_{GS} = -10V, I_{D} = -0.42A$
Static Dialii-Source Off-Resistance	RDS(ON)	_	0.78	1.7	12	$V_{GS} = -4.5V$, $I_{D} = -0.2A$
Diode Forward Voltage	V_{SD}	_	-0.8	-1.2	V	$V_{GS} = 0V$, $I_{S} = -0.23A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss	_	19	_	рF	45)/ 1/ 0)/
Output Capacitance	Coss	_	16	_	pF	V _{DS} = -15V, V _{GS} = 0V, -f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	3		рF	I = 1.0IVII IZ
Gate Resistance	R_g		729	_	Ω	$V_{DS} = V_{GS} = 0V$, $f = 1.0MHz$
Total Gate Charge (Vgs = -4.5V)	Qg		0.36	_	nC	
Total Gate Charge (V _{GS} = -10V)	Qg		0.8	_	nC	V _{DS} = -10V, I _D = -0.24A
Gate-Source Charge	Qgs	_	0.1	_	nC	VDS = -10V, ID = -0.24A
Gate-Drain Charge	Q _{gd}	_	0.1	_	nC	
Turn-On Delay Time	tD(ON)	_	30	_	ns	
Turn-On Rise Time	t _R	_	74	_	ns	$V_{GS} = -10V, V_{DD} = -15V,$
Turn-Off Delay Time	t _{D(OFF)}	_	28	_	ns	$I_D = -0.5A, R_G = 1\Omega$
Turn-Off Fall Time	tF	_	31	_	ns	

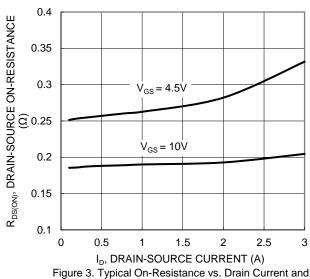
Notes: 7. Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to product testing.



Typical Characteristics - N-CHANNEL





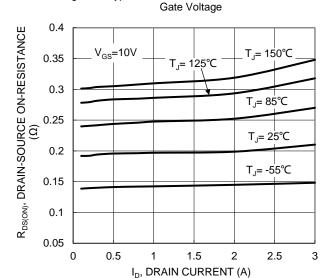


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

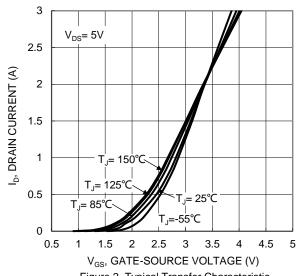
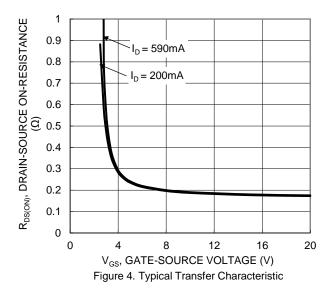


Figure 2. Typical Transfer Characteristic



1.8 R_{DS(ON)}, DRAIN-SOURCE ON-RESISTANCE (NORMALIZED) 1.6 $V_{GS} = 10V, I_D = 590mA$ 1.4 1.2 1 $V_{GS} = 4.5V, I_D = 200mA$ 0.8 0.6 -50 -25 25 50 75 100 125 150

T_J, JUNCTION TEMPERATURE (°C) Figure 6. On-Resistance Variation with Temperature



Typical Characteristics - N-CHANNEL (continued)

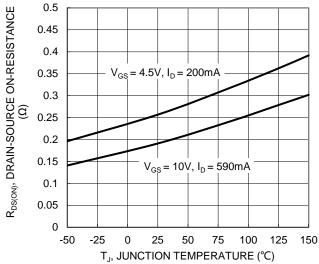
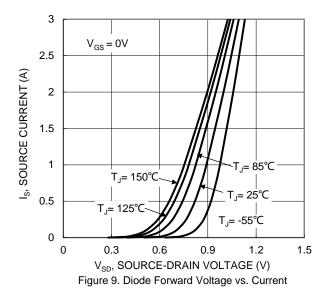


Figure 7. On-Resistance Variation with Temperature



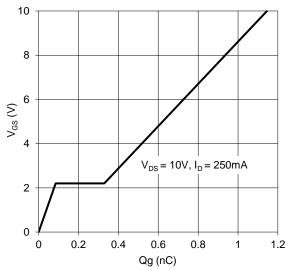
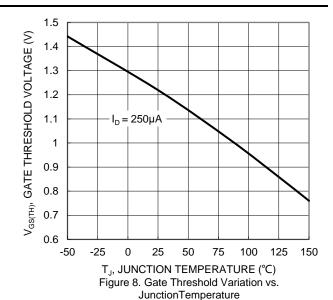
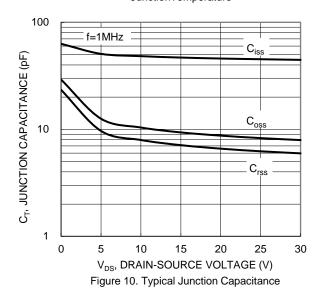
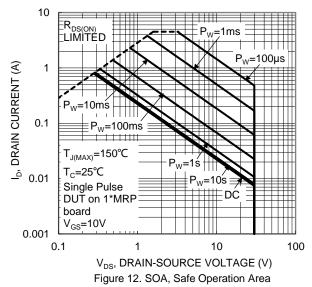


Figure 11. Gate Charge

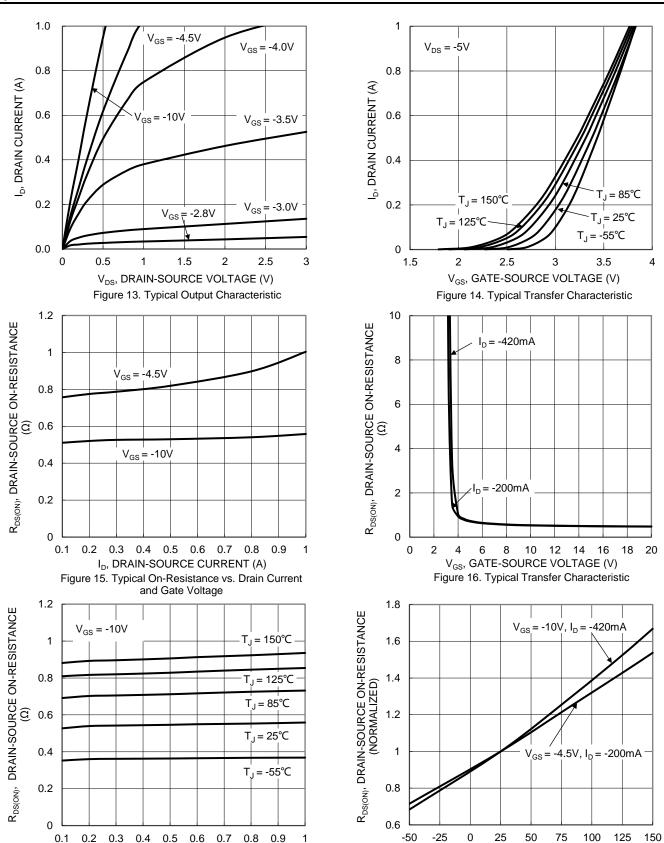








Typical Characteristics - P-CHANNEL



0.1

0.2 0.3 0.4 0.5 0.6 0.7 0.8

I_D, DRAIN CURRENT (A)

Figure 17. Typical On-Resistance vs. Drain Current

and Junction Temperature

-50

T_J, JUNCTION TEMPERATURE (°C)

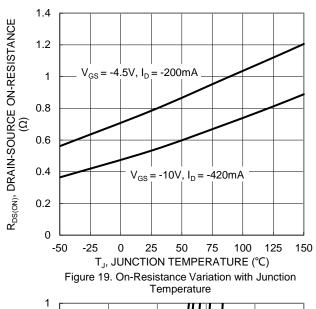
Figure 18. On-Resistance Variation with Junction

Temperature

0.9



Typical Characteristics - P-CHANNEL (continued)



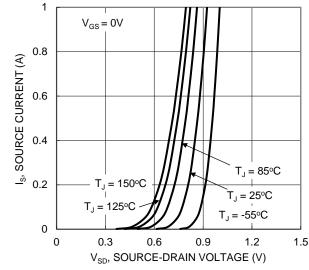


Figure 21. Diode Forward Voltage vs. Current 10 8 6 $V_{GS}(V)$ $V_{DS} = -10V, I_{D} = -0.24A$ 4 2 0 0.1 0.2 0.3 0.4 0.5 0.6 0.7 0.8 0.9 1 Q_g (nC)

Figure 23. Gate Charge

 $V_{GS(TH)},$ GATE THRESHOLD VOLTAGE (V) 2.8 2.6 2.4 2.2 2 $I_D = -250 \mu A$ 1.8 1.6 1.4 1.2 0.8 -25 0 25 50 75 100 125 -50 150 T_{.i}, JUNCTION TEMPERATURE (°C) Figure 20. Gate Threshold Variation vs. Junction Temperature

3

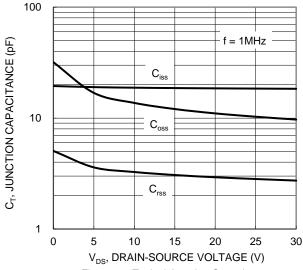
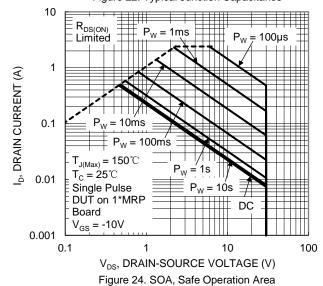


Figure 22. Typical Junction Capacitance



DMC3401LDW



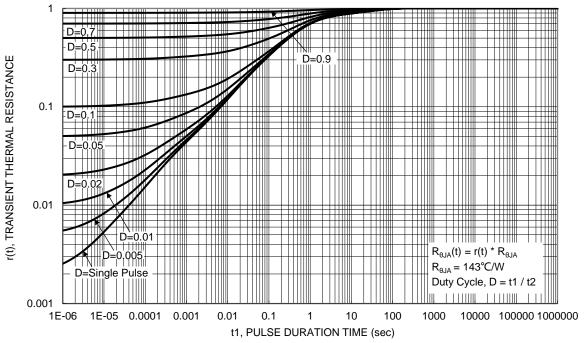


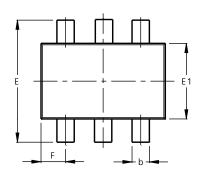
Figure 25. Transient Thermal Resistance

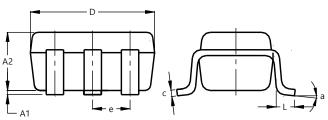


Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT363



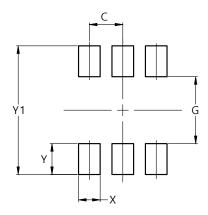


SOT363							
Dim	Min	Max	Тур				
A1	0.00	0.10	0.05				
A2	0.90	1.00	0.95				
b	0.10	0.30	0.25				
C	0.10	0.22	0.11				
D	1.80	2.20	2.15				
Е	2.00	2.20	2.10				
E1	1.15	1.35	1.30				
е	0.650 BSC						
F	0.40	0.45	0.425				
L	0.25	0.40	0.30				
а	0°	8°					
All I	Dimen	sions	in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT363



Dimensions	Value (in mm)
C	0.650
G	1.300
Х	0.420
Υ	0.600
V1	2 500



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